# **ON Semiconductor**

# Is Now



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**Preferred Device** 

# **SWITCHMODE™ Power Rectifier**

These state-of-the-art devices are designed for use in switching power supplies, inverters and as free wheeling diodes.

#### **Features**

- Ultrafast 50 Nanosecond Recovery Times
- 175°C Operating Junction Temperature
- Low Forward Voltage
- Low Leakage Current
- High Temperature Glass Passivated Junction
- These are Pb-Free Devices\*

#### **Mechanical Characteristics:**

- Case: Epoxy, Molded
- Weight: 0.4 Gram (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds
- Shipped in Plastic Bags; 1,000 per Bag
- Available Tape and Reel; 5,000 per Reel, by Adding a "RL" Suffix to the Part Number

#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	600 -	٧
Average Rectified Forward Current (Note 1) (Square Wave Mounting Method #3 Per Note 3)	I <sub>F(AV)</sub>	2.0 @ T <sub>A</sub> = 60°C	Α
Non-Repetitive Peak Surge Current (Surge applied at rated load conditions, halfwave, single phase, 60 Hz)	I <sub>FSM</sub>	35	A
Operating Junction Temperature and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-65 to +175	°C

#### THERMAL CHARACTERISTICS

Characteristics	Symbol	Value	Unit
Maximum Thermal Resistance, Junction–to–Ambient	$R_{\theta JA}$	See Note 3	°C/W

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

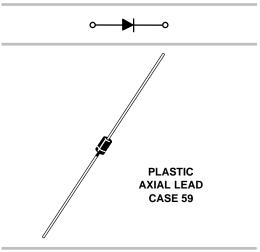
1. Pulse Test: Pulse Width = 300  $\mu$ s, Duty Cycle  $\leq$  2.0%.



#### ON Semiconductor®

http://onsemi.com

## **ULTRAFAST RECTIFIER** 2.0 AMPERES, 600 VOLTS



#### **MARKING DIAGRAM**



A = Assembly Location

= Year

WW = Work Week

= Pb–Free Package

(Note: Microdot may be in either location)

#### ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>
MUR260	Axial Lead**	1000 Units/Bag
MUR260G	MUR260G Axial Lead** 1000	
MUR260RL Axial Lead** 5	5000/Tape & Reel	
MUR260RLG	Axial Lead**	5000/Tape & Reel

- †For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
- \*\*This package is inherently Pb-Free.

**Preferred** devices are recommended choices for future use and best overall value.

<sup>\*</sup>For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

#### **ELECTRICAL CHARACTERISTICS**

Characteristics	Symbol	Value	Unit
Maximum Instantaneous Forward Voltage (Note 2) ( $I_F = 2.0 \text{ Amp}, T_J = 150^{\circ}\text{C}$ ) ( $I_F = 2.0 \text{ Amp}, T_J = 25^{\circ}\text{C}$ )	VF	1.15 1.35	V
Maximum Instantaneous Reverse Current (Note 2) (Rated dc Voltage, $T_J = 150^{\circ}C$ ) (Rated dc Voltage, $T_J = 25^{\circ}C$ )	i <sub>R</sub>	150 5.0	μΑ
Maximum Reverse Recovery Time ( $I_F$ = 1.0 Amp, di/dt = 50 Amp/ $\mu$ s) ( $I_F$ = 0.5 Amp, $I_R$ = 1.0 Amp, $I_{REC}$ = 0.25 A)	t <sub>rr</sub>	75 50	ns
Maximum Forward Recovery Time ( $I_F = 1.0 \text{ A}$ , di/dt = 100 A/ $\mu$ s, $I_{REC}$ to 1.0 V)	t <sub>fr</sub>	50	ns

<sup>2.</sup> Pulse Test: Pulse Width = 300 µs, Duty Cycle ≤ 2.0%.

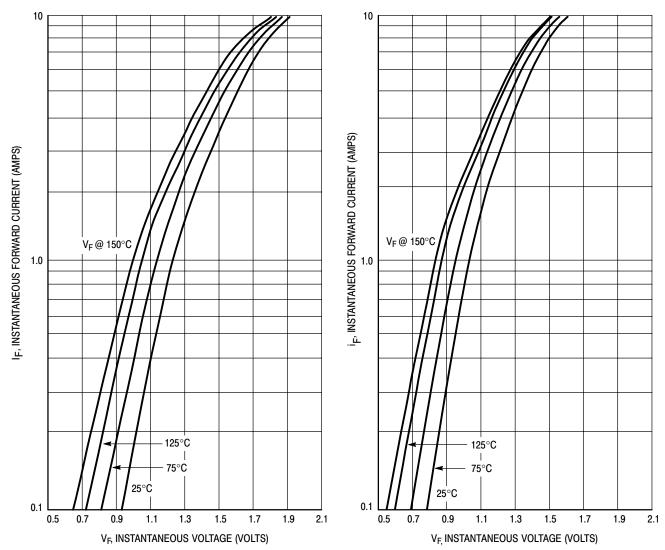


Figure 1. Maximum Forward Voltage

Figure 2. Typical Forward Voltage

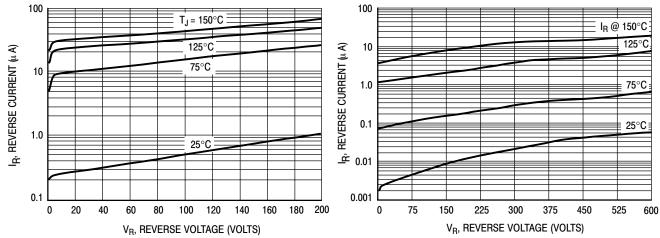
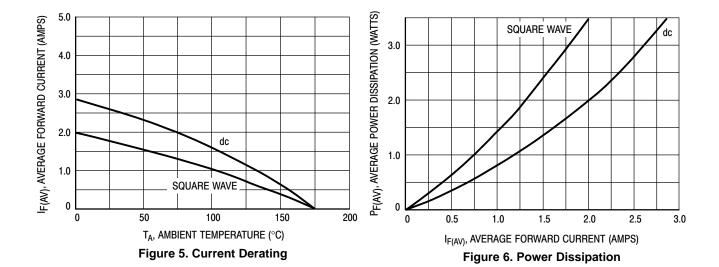


Figure 3. Maximum Reverse Current

Figure 4. Typical Reverse Current



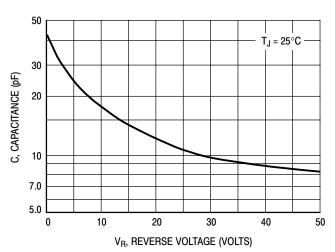


Figure 7. Typical Capacitance

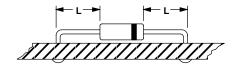
#### NOTE 3 — AMBIENT MOUNTING DATA

Data shown for thermal resistance, junction—to—ambient  $(R_{\theta JA})$  for the mountings shown is to be used as typical guideline values for preliminary engineering or in case the tie point temperature cannot be measured.

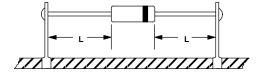
TYPICAL VALUES FOR  $R_{\theta \text{JA}}$  IN STILL AIR

Mounting		Lead Length, L			
Method		1/8	1/4	1/2	Units
1		52	65	72	°C/W
2	$R_{\theta JA}$	67	80	87	°C/W
3			50		°C/W

#### **MOUNTING METHOD 1**

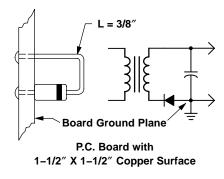


#### **MOUNTING METHOD 2**



**Vector Pin Mounting** 

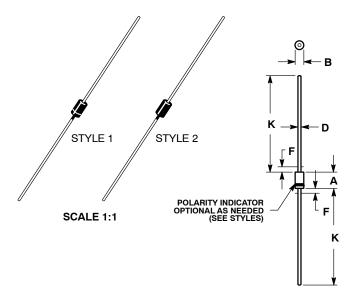
#### **MOUNTING METHOD 3**



SWITCHMODE is a trademark of Semiconductor Components Industries, LLC.

#### **AXIAL LEAD** CASE 59-10 **ISSUE U**

**DATE 15 FEB 2005** 

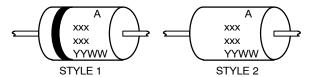


- NOTES:
  1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  2. CONTROLLING DIMENSION: INCH.

- CONTROLLING DIMENSION: INCH.
  ALL RULES AND NOTES ASSOCIATED WITH
  JEDEC DO-41 OUTLINE SHALL APPLY
  POLARITY DENOTED BY CATHODE BAND.
  LEAD DIAMETER NOT CONTROLLED WITHIN F
  DIMENSION.

	INCHES		MILLIM	ETERS
DIM	MIN	MAX	MIN	MAX
Α	0.161	0.205	4.10	5.20
В	0.079	0.106	2.00	2.70
D	0.028	0.034	0.71	0.86
F		0.050		1.27
K	1.000		25.40	

#### **GENERIC MARKING DIAGRAM\***



XXX = Specific Device Code = Assembly Location Α

YY = Year WW = Work Week

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

STYLE 1: PIN 1. CATHODE (POLARITY BAND) STYLE 2: NO POLARITY 2. ANODE

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